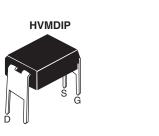
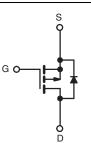


Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 60			
R _{DS(on)} (Ω)	V _{GS} = - 10 V	0.50		
Q _g (Max.) (nC)	12			
Q _{gs} (nC)	3.8			
Q _{gd} (nC)	5.1			
Configuration	Single			





P-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain servers as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION			
Package	HVMDIP		
Lead (Pb)-free	IRFD9014PbF		
Lead (FD)-iree	SiHFD9014-E3		
SnPb	IRFD9014		
SIFD	SiHFD9014		

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	- 60	W	
Gate-Source Voltage			V _{GS}	± 20	V	
Continuous Drain Current	V at 10.V	$T_A = 25 ^{\circ}\text{C}$ $T_A = 100 ^{\circ}\text{C}$	I _D	- 1.1	А	
	V _{GS} at - 10 V	T _A = 100 °C		- 0.80		
Pulsed Drain Current ^a			I _{DM}	- 8.8		
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	140	mJ	
Avalanche Current ^a			I _{AR}	- 1.1	Α	
Repetitive Avalanche Energy ^a			E _{AR}	0.13	mJ	
Maximum Power Dissipation	T _A = 25 °C		P_{D}	1.3	W	
Peak Diode Recovery dV/dt ^c			dV/dt	- 4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	- °C	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d		

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD} = -25$ V, starting $T_J = 25$ °C, L = 33 mH, $R_g = 25$ Ω , $I_{AS} = -2.2$ A (see fig. 12). c. $I_{SD} \le -6.7$ A, $dI/dt \le 90$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFD9014, SiHFD9014

Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R_{thJA}	-	120	°C/W	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA		- 60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = - 1 mA	-	- 0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zana Oala Wallana Buria Oanada		V _{DS} =	V _{DS} = - 60 V, V _{GS} = 0 V		-	-100	^
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 48 \	/, V _{GS} = 0 V, T _J = 150 °C	-	-	- 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 0.66 A ^b	-	-	0.50	Ω
Forward Transconductance	9 _{fs}	V _{DS} = -	25 V, I _D = - 0.66 A ^b	0.70	-	-	S
Dynamic							
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	270	-	
Output Capacitance	C _{oss}		$V_{GS} = 0 \text{ V},$ $V_{DS} = -25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		170	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.			31	-	
Total Gate Charge	Qg			-	-	12	nC
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	I _D = - 6.7 A, V _{DS} = - 48 V, see fig. 6 and 13 ^b	-	-	3.8	
Gate-Drain Charge	Q _{gd}	1	See lig. o and 15	-	-	5.1	
Turn-On Delay Time	t _{d(on)}		L	-	11	-	
Rise Time	t _r	V_{DD} = - 30 V, I_{D} = - 6.7 A, R_{g} = 24 Ω, R_{D} = 4.0 Ω, see fig. 10 ^b		-	63	-	ns
Turn-Off Delay Time	t _{d(off)}			-	10	-	
Fall Time	t _f			-	31	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	-11
Internal Source Inductance	L _S			-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 1.1	_
Pulsed Diode Forward Current ^a	I _{SM}			-	-	- 8.8	- A
Body Diode Voltage	V _{SD}	T _J = 25 °C,	T _J = 25 °C, I _S = - 1.1 A, V _{GS} = 0 V ^b		-	- 5.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1	0.7.4 .11/.11 .400.4/ .5	-	80	160	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = -6.7 \text{A}, \text{dI/dt} = 100 \text{A/} \mu \text{s}^{\text{b}}$		-	0.096	0.19	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	v Ls and	L _D)

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

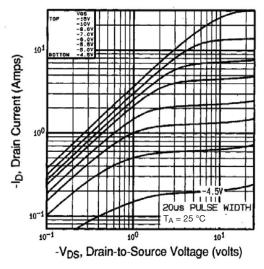


Fig. 1 - Typical Output Characteristics, T_A = 25 °C

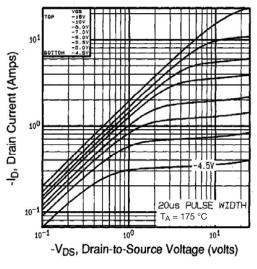
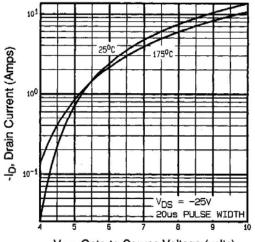


Fig. 2 - Typical Output Characteristics, T_A = 175 °C



-VGS, Gate-to-Source Voltage (volts)

Fig. 3 - Typical Transfer Characteristics

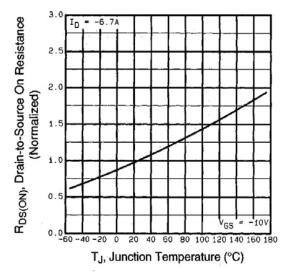


Fig. 4 - Normalized On-Resistance vs. Temperature



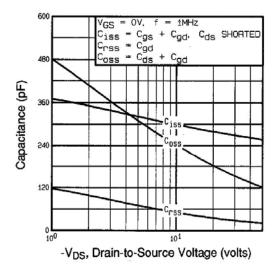


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

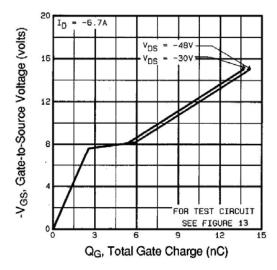


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

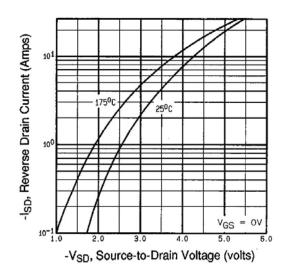


Fig. 7 - Typical Source-Drain Diode Forward Voltage

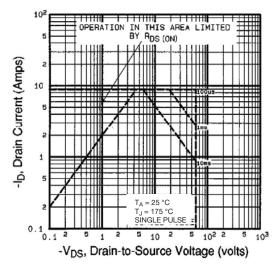


Fig. 8 - Maximum Safe Operating Area





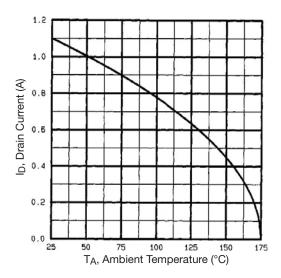


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

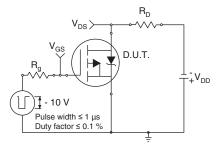


Fig. 10a - Switching Time Test Circuit

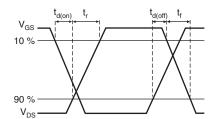


Fig. 10b - Switching Time Waveforms

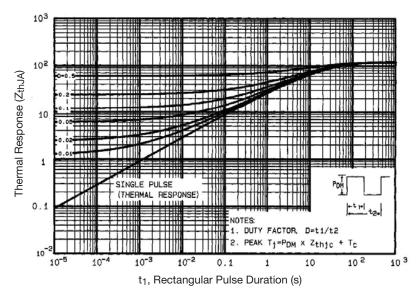


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



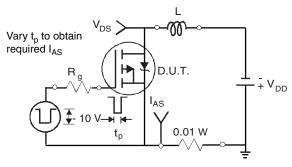


Fig. 12a - Unclamped Inductive Test Circuit

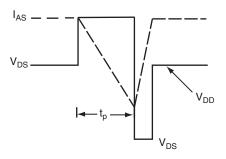


Fig. 12b - Unclamped Inductive Waveforms

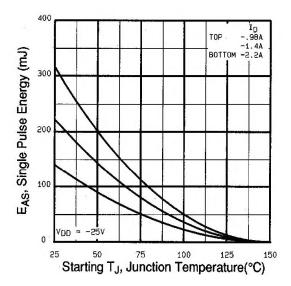


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

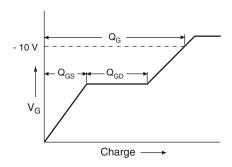


Fig. 13a - Basic Gate Charge Waveform

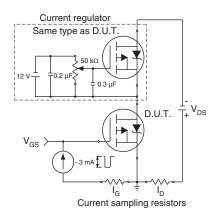
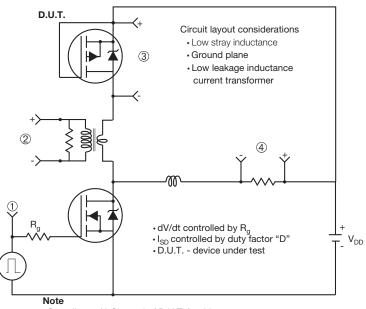


Fig. 13b - Gate Charge Test Circuit

Peak Diode Recovery dV/dt Test Circuit



· Compliment N-Channel of D.U.T. for driver

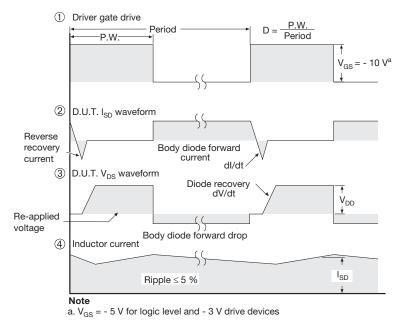
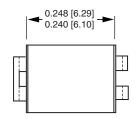
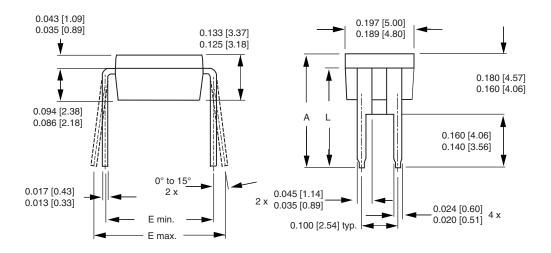


Fig. 14 - For P-Channel

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HVM DIP (High voltage)





	INCHES		MILLIMETERS		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	0.310	0.330	7.87	8.38	
E	0.300	0.425	7.62	10.79	
L	0.270	0.290	6.86	7.36	

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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